503339370 06/08/2015

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Yi-Wei Chen	11/24/2009
Nien-Ting Ho	11/24/2009
Chien-Chung Huang	11/24/2009
Chin-Fu Lin	11/24/2009

RECEIVING PARTY DATA

Name:	UNITED MICROELECTRONICS CORP.
Street Address:	No.3, Li-Hsin Road 2, Science-Based Industrial Park
City:	Hsin-Chu City
State/Country:	TAIWAN

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14698828

CORRESPONDENCE DATA

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NAME OF SUBMITTER:	KATE YEH
SIGNATURE:	/KATE YEH/
DATE SIGNED:	06/08/2015

Total Attachments: 2 source=2264385#page1.tif source=2264385#page2.tif

PATENT 503339370 REEL: 035799 FRAME: 0070

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

Name:	Yi-Wei Chen	Nationality:	TW
Name:	Nien-Ting Ho	Nationality:	TW
Name:	Chien-Chung Huang	Nationality:	TW
Name:	Chin-Fu Lin	Nationality:	TW
Hereby sells, a	ssigns and transfers to		
.SSIGNEE(S			
Name:	UNITED MICROELECTRONICS CORP.		
Address:	No.3, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu City 300, Taiwa R.O.C.		Chu City 300, Taiwan,
	ssors and assignees of the ASSIGNEE the ent provements which are disclosed in the invention	• .	nd interest in and to
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PATENT

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this NOV 2 4 2009 (Date of signing). (特殊用人物必要带上列目期上)

(Type name of inventor) <u>Yi-Wei Chen</u>	Signature of INVENTOR Yi-Wei (Men
Nien-Ting Ho	Vien-Ting Ho
Chien-Chung Huang	Chren-Chung Huong
Chin-Fu Lin	China ha Isra

Assignment, Page 2 of 2

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